

# **NCE N-Channel Super Trench II Power MOSFET**

## **Description**

The series of devices uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

## **Application**

- DC/DC Converter
- •Ideal for high-frequency switching and synchronous rectification

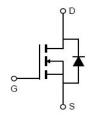
#### **General Features**

- $V_{DS}$  =120V, $I_D$  =65A  $R_{DS(ON)}$ =8.7m $\Omega$  , typical @  $V_{GS}$ =10V
- Excellent gate charge x R<sub>DS(on)</sub> product(FOM)
- Very low on-resistance R<sub>DS(on)</sub>
- 175 °C operating temperature
- Pb-free lead plating

100% UIS TESTED! 100% ΔVds TESTED!

#### TO-252





**Schematic Diagram** 

# **Package Marking and Ordering Information**

<b>Device Marking</b>	Device	Device Package	Reel Size	Tape width	Quantity
NCEP10N12K	NCEP10N12K	TO-252-2L	-	-	-

## Absolute Maximum Ratings (T<sub>c</sub>=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	120	V
Gate-Source Voltage	V <sub>G</sub> s	±20	V
Drain Current-Continuous	I <sub>D</sub>	65	Α
Drain Current-Continuous(T <sub>C</sub> =100 °C)	I <sub>D</sub> (100℃)	46	А
Pulsed Drain Current	I <sub>DM</sub>	260	Α
Maximum Power Dissipation	P <sub>D</sub>	120	W
Derating factor		0.8	W/℃
Single pulse avalanche energy (Note 4)	E <sub>AS</sub>	352	mJ
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 175	°C

#### **Thermal Characteristic**

Thermal Resistance, Junction-to-Case	R <sub>eJC</sub>	1.25	°C/W
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Electrical Characteristics (T<sub>C</sub>=25°Cunless otherwise noted)

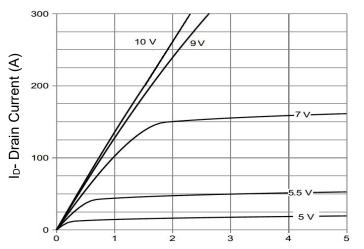
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						•
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	120		-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =120V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}=\pm20V, V_{DS}=0V$	-	-	±100	nA
On Characteristics (Note 3)	,					
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	2.0	3.0	4.0	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =35A	-	8.7	10.0	mΩ
Forward Transconductance	<b>G</b> FS	V <sub>DS</sub> =5V,I <sub>D</sub> =35A		60	-	S
Dynamic Characteristics (Note3)	,		,			
Input Capacitance	C <sub>lss</sub>	V <sub>DS</sub> =60V,V <sub>GS</sub> =0V, F=1.0MHz		3050	-	pF
Output Capacitance	Coss			280	-	pF
Reverse Transfer Capacitance	Crss			22	-	pF
Switching Characteristics (Note 3)			•		1	•
Turn-on Delay Time	t <sub>d(on)</sub>		-	15	-	nS
Turn-on Rise Time	tr	V <sub>GS</sub> =0V I <sub>D</sub> =250μA 1 V <sub>DS</sub> =120V,V <sub>GS</sub> =0V V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V  V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA 2 V <sub>GS</sub> =10V, I <sub>D</sub> =35A V <sub>DS</sub> =5V,I <sub>D</sub> =35A  V <sub>DS</sub> =60V,V <sub>GS</sub> =0V,	-	10	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10 $V$ , $R_{G}$ =1.6 $\Omega$	-	34	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	8	-	nS
Total Gate Charge	Qg	V 00VI 05A	-	53	-	nC
Gate-Source Charge	Q <sub>gs</sub>	, , ,	-	20	-	nC
Gate-Drain Charge	$Q_{gd}$	V <sub>GS</sub> =10V	-	12.5	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 2)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =35A	-	-	1.2	V
Diode Forward Current	Is		-	-	65	Α
Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25^{\circ}C, I_F = 35A$	-	60	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	106	-	nC

#### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- 3. Guaranteed by design, not subject to production
- 4. EAS condition : Tj=25  $^{\circ}\text{C}$  ,V\_DD=50V,V\_G=10V,L=0.25mH,Rg=25 $\Omega$
- 5. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsin k, assuming a maximum junction temperature of TJ(MAX)=175° C. The SOA curve provides a single pulse rating

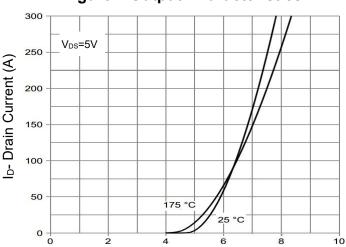


## **Typical Electrical and Thermal Characteristics**



Vds Drain-Source Voltage (V)

**Figure 1 Output Characteristics** 



Vgs Gate-Source Voltage (V)
Figure 2 Transfer Characteristics

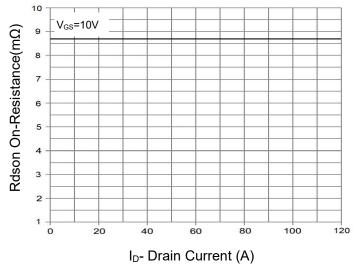


Figure 3 Rdson- Drain Current

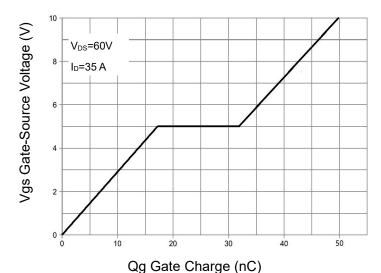


Figure 4 Gate Charge

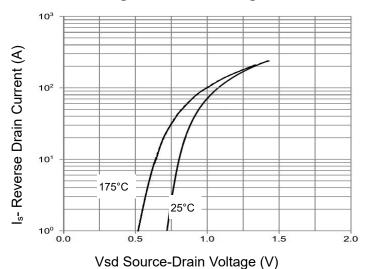


Figure 5 Source- Drain Diode Forward

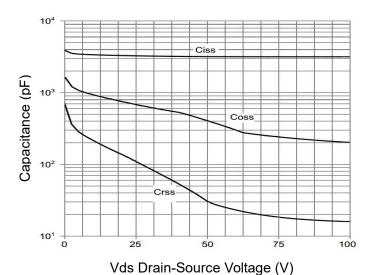


Figure 6 Capacitance vs Vds



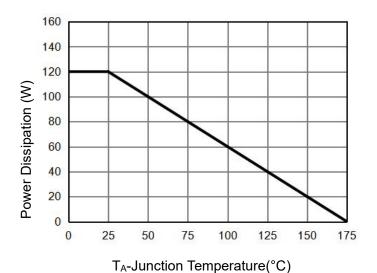
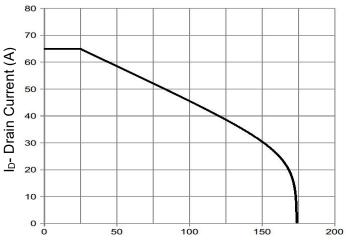


Figure 7 Power De-rating



T<sub>A</sub>-Junction Temperature (°C) **Figure 9 Current De-rating** 

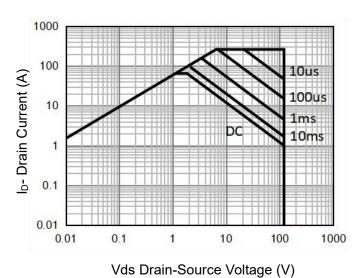


Figure 8 Safe Operation Area (Note 5)

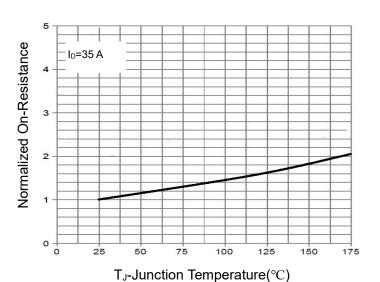
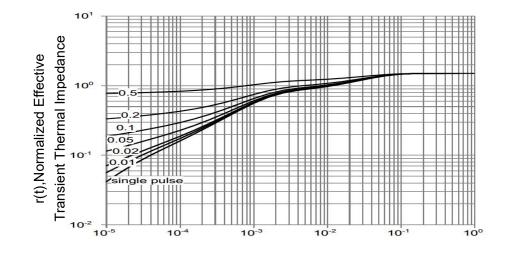


Figure 10 Rdson-Junction Temperature

V3.0

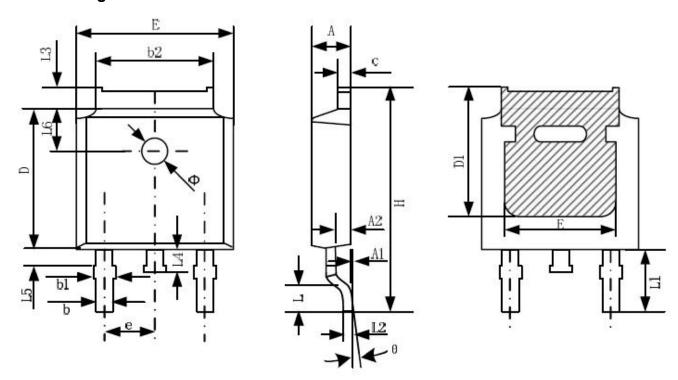


Square Wave Pluse Duration(sec)

**Figure 11 Normalized Maximum Transient Thermal Impedance** 



**TO-252-2L Package Information** 



Symbol	Dimensions In Millimeters		Dimensions In Inches	
Symbol	Min.	Max.	Min.	Max.
Α	2.20	2.38	0.087	0.094
A1	0.00	0.10	0.000	0.004
A2	0.90	1.10	0.035	0.043
b	0.72	0.85	0.028	0.033
b1	0.72	0.90	0.028	0.035
b2	5.13	5.46	0.202	0.215
С	0.47	0.60	0.019	0.024
D	6.00	6.20	0.236	0.244
D1	5.25		0.207	#1
E	6.50	6.70	0.256	0.264
E1	4.70	920	0.185	1447
e	2.19	2.39	0.086	0.094
Н	9.80	10.40	0.386	0.409
L	1.40	1.70	0.055	0.067
L1	2.90	REF	0.114	REF
L2	0.508 BSC		0.020	BSC
L3	0.90	1.25	0.035	0.049
L4	0.60	1.00	0.024	0.039
L5	0.15	0.75	0.006	0.030
L6	1.80 REF		0.071 REF	
Φ	1.20	1.40	0.047	0.055
θ	0°	8°	0°	8°



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